



SCOPE: With the explosion of research activity and reports, the need for concise and critical reviews of topics of contemporary research interest is manifest. *Reviews of Adhesion and Adhesives* (RAA) provides in-depth, incisive, illuminating and thought-provoking reviews written by subject matter experts covering all aspects of adhesion science and adhesive technology. Each review will be imbued with the author's experience so that the reader will be able to assimilate the research in the area discussed easily and will be able to apply it in practice. The journal has relevance to a myriad of industries including textiles, printing, coatings, aerospace, medical, nanotechnology, biotechnology, building and construction, and microelectronics. The topics to be covered include, but not limited to, basic and theoretical aspects of adhesion; modeling of adhesion phenomena; mechanisms of adhesion; surface and interfacial analysis and characterization; unraveling of events at interfaces; characterization of interphases; adhesion of thin films and coatings; adhesion aspects in reinforced composites; formation, characterization and durability of adhesive joints; surface preparation methods; polymer surface modification; biological adhesion; particle adhesion; adhesion of metallized plastics; adhesion of diamond-like films; adhesion promoters; contact angle, wettability and adhesion; superhydrophobicity and superhydrophilicity. With regard to adhesives, RAA will include, but not limited to, green adhesives; novel and high-performance adhesives; and medical adhesive applications.

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ABOUT THE EDITOR: **Kashmiri Lal Mittal** was associated with the IBM Corporation from 1972 through 1993. Currently, he is teaching and consulting worldwide in the broad areas of adhesion as well as surface cleaning. Kash is a Robert L. Patrick Fellow of the Adhesion Society; he co-founded the *Journal of Adhesion Science and Technology* of which he was the Editor-in-Chief until April 2012; he was recognized for his contributions and accomplishments by the worldwide adhesion community by organizing in his honor to mark his 50th birthday the 1st International Congress on Adhesion Science & Technology in Amsterdam in 1995; in 2002 he was honored by the global surfactant community by inaugurating the Kash Mittal Award in his honor for his significant contribution to the field of colloid and interface chemistry; and in 2003 he was honored by the Maria Curie-Skłodowska University, Lublin, Poland by awarding him the title of doctor *honoris causa*. In addition, he is the editor of 110 books dealing with adhesion measurement, adhesion of polymeric coatings, polymer surfaces, adhesive joints, adhesion promoters, thin films, polyimides, surface modification, surface cleaning, and surfactants.

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